

	1010
attaching a die to a substrate	
	011
isolating the component or die the space between the die and the substra	ite
/10	212
heating a mold	
	14
placing a thermally conductive heat spreader into the mold	
101	6
placing the substrate into the mold	
	017
removing reactive elements from the space between the die and the	
thermally conductive heat spreader	
	<u>०। </u>
placing a pressure on the molten metal material	
	019
flowing a molten metal material into contact with the thermally conducti	ive
heat spreader and the die	
/10	220
cooling the mold, and thermally conductive heat spreader to solidify the	
molten metal material	

Fig. 10

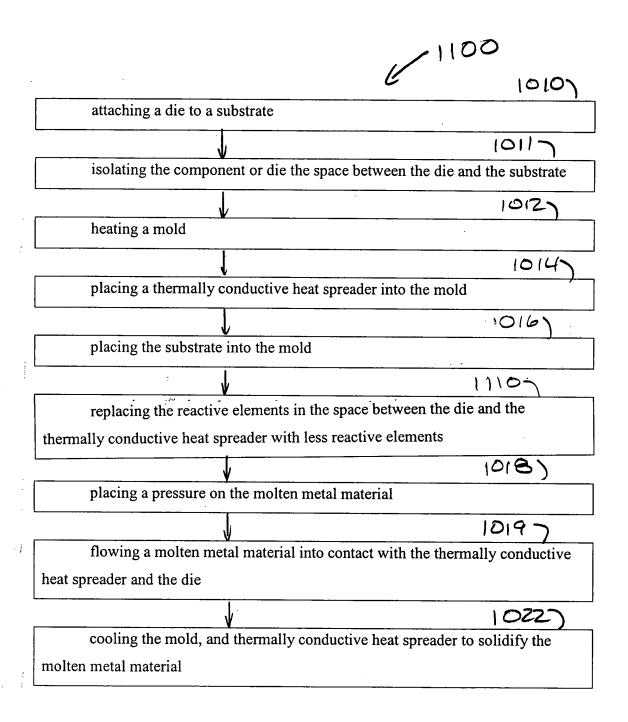


Fig. 11

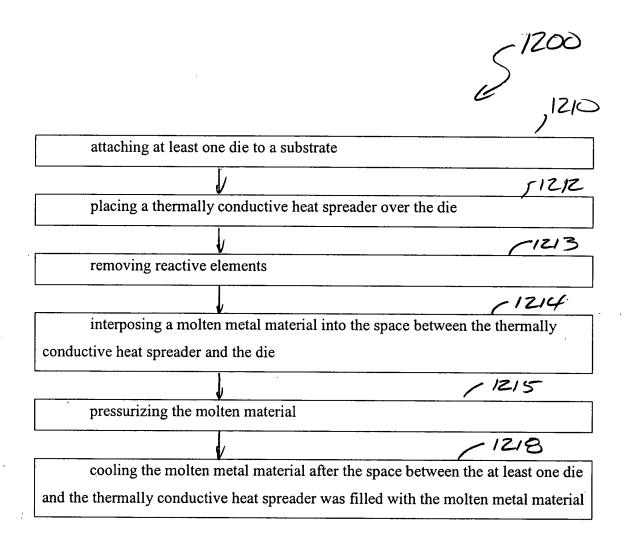


FIG. 12